

**Search Notes**

Application/Control No.

09/625,178

Examiner

Anh D. Mai

Applicant(s)/Patent under  
Reexamination

NAKAMURA, HIROKI

Art Unit

2814

**SEARCHED**

Class	Subclass	Date	Examiner
257	635; 637 642; 758-760	5/3/2005	A.M

**INTERFERENCE SEARCHED**

Class	Subclass	Date	Examiner

**SEARCH NOTES  
(INCLUDING SEARCH STRATEGY)**

	DATE	EXMR
EAST (all) * Inventor * CCLS *(bonding pad) and moisture and substrate and wiring	5/3/2005	A.M
JPO (web): patent number search	5/3/2005	A.M